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SEMICONDUCTOR®

November 2013

### FQD10N20L **N-Channel QFET® MOSFET** 200 V, 7.6 A, 360 mΩ

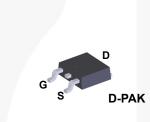
### Description

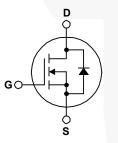
This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance • Low Crss (Typ. 14 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

#### Features

- 7.6 A, 200 V, R<sub>DS(on)</sub> = 360 mΩ (Max.) @ V<sub>GS</sub> = 10 V,  $I_{D} = 3.8 \text{ A}$
- Low Gate Charge (Typ. 13 nC)

- · Low Level Gate Drive Requirements Allowing **Direct Operation Form Logic Drivers**





#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

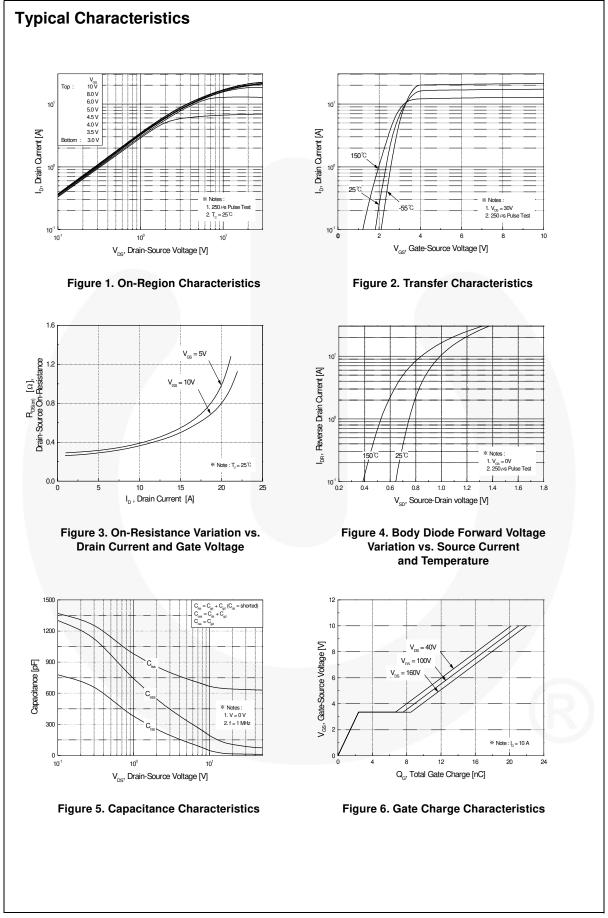
Symbol	Parameter		FQD10N20LTM	Unit V	
V <sub>DSS</sub>	Drain-Source Voltage		200		
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		7.6	А	
	- Continuous (T <sub>C</sub> = 100°C)		4.8	A	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	30.4	А	
V <sub>GSS</sub>	Gate-Source Voltage		± 20	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	180	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		7.6	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		5.1	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns	
P <sub>D</sub>	Power Dissipation ( $T_A = 25^{\circ}C$ ) *		2.5 V		
	Power Dissipation ( $T_C = 25^{\circ}C$ )		51	W	
	- Derate above 25°C		0.4	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		300	°C	

#### **Thermal Characteristics**

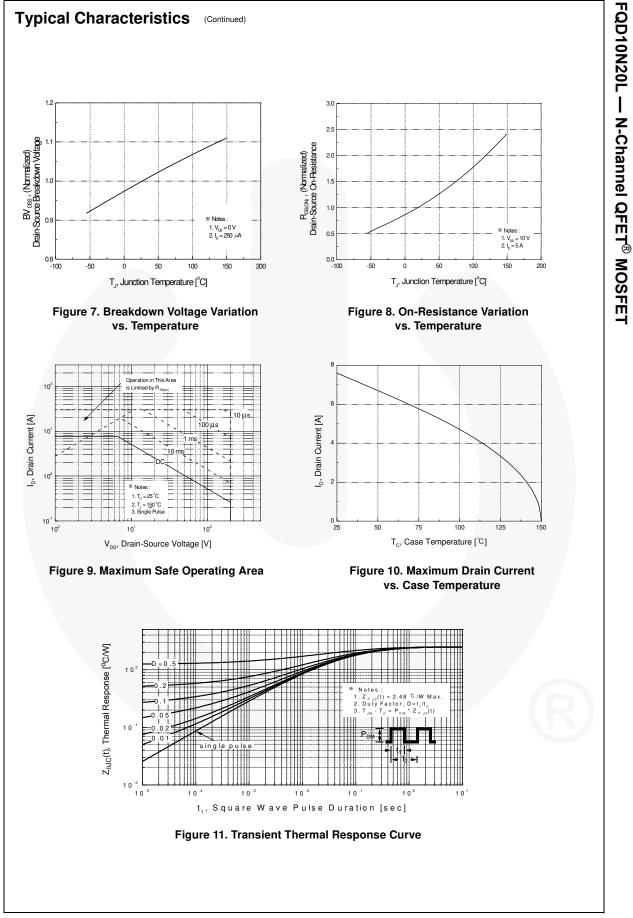
Symbol	Parameter	FQD10N20LTM	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.48	
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	50	

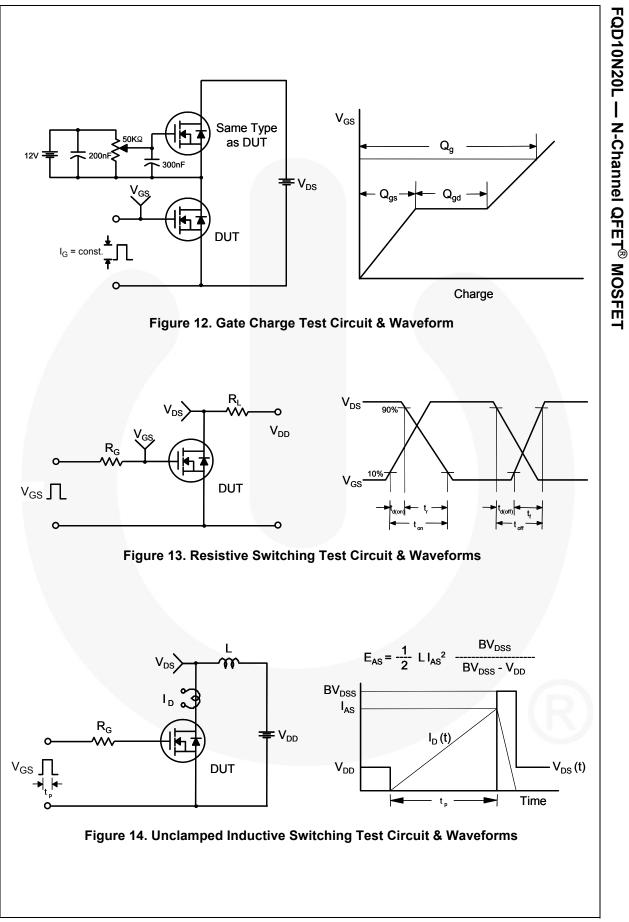
lectri			Pack	<b>03</b>		Size	Tape Width		Quantity		
	0N20LTM	FQD10N20L	DF	PAK Tape and Reel 330		330	mm	16 mm		2500 units	
	cal Char	acteristics	T 05%	C laca oth							
		Parameter	IC = 25-0	3 unless our	Test Con	Jillone		Min.	Tun	Max	. Unit
Symbol		Farameter			Test Con	aluons		IVIIII.	Тур.	Ινιαλ	. Ont
	aracteristic	s			_						
BV <sub>DSS</sub>	Drain-Sourc	ce Breakdown Voli	age	$V_{GS} = 0$	) V, I <sub>D</sub> = 25	i0 μA		200			V
∆BV <sub>DSS</sub>		Voltage Temperat	ure	I <sub>D</sub> = 250	0 μA, Refe	renced to	o 25°C		0.18		V/°C
/ΔT <sub>J</sub>	Coefficient			V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V						 	
I <sub>DSS</sub>	Zero Gate \	Voltage Drain Curr	ent	$v_{DS} = 200 \text{ V}, v_{GS} = 0 \text{ V}$ $V_{DS} = 160 \text{ V}, T_{C} = 125^{\circ}\text{C}$					1 10	μΑ μΑ	
IGSSF	Gate-Body	Gate-Body Leakage Current, Forward		$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$					100	nA	
I <sub>GSSR</sub>		Gate-Body Leakage Current, Reverse		$V_{GS} = -20 V, V_{DS} = 0 V$ $V_{GS} = -20 V, V_{DS} = 0 V$						-100	
									I		
	racteristic	;s									
V <sub>GS(th)</sub>		hold Voltage		-	$I_{\rm GS}, I_{\rm D} = 2$			1.0		2.0	V
R <sub>DS(on)</sub>	Static Drain On-Resista			0.0	10 V, I <sub>D</sub> = 3 5 V, I <sub>D</sub> = 3.				0.29 0.3	0.36	
0 <sub>F0</sub>		ansconductance			30 V, I <sub>D</sub> = 3. 30 V, I <sub>D</sub> = 3				9.6	0.30	S
9 <sub>FS</sub>	TOIWald IIa			•DS = C	ло <b>v</b> , п <u>р</u> = с	.0 /			3.0		5
Dynam	ic Charact	eristics									
C <sub>iss</sub>	Input Capac	citance		$V_{DS} = 2$	25 V, V <sub>GS</sub> =	= 0 V,			640	830	pF
C <sub>oss</sub>	Output Cap	acitance		f = 1.0 I					95	125	pF
C <sub>rss</sub>	Reverse Tra	ansfer Capacitanc	е						14	18	pF
Cwitch	ing Chara	atariatiaa									
	ing Charac Turn-On De			1					13	35	ns
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Ris	,			100 V, I <sub>D</sub> =	10 A,			150	310	ns
t <sub>d(off)</sub>	Turn-Off De		_	R <sub>G</sub> = 28	5Ω		(Note 4)		50	110	ns
u(uii)	Turn-Off Fa	-	_	-			. ,		95	200	ns
t <sub>f</sub>	Total Gate 0	Charge		$V_{DC} = 1$	160 V, I <sub>D</sub> =	10 A.			13	17	nC
				$V_{GS} = 5 V$		,	(Note 4)		2.4		
t <sub>f</sub> Q <sub>g</sub> Q <sub>qs</sub>	Gate-Sourc	e Charge		$V_{GS} = 5$	5 V		(11018 4)		··		nC
Q <sub>g</sub> Q <sub>gs</sub>				V <sub>GS</sub> = 5	5 V		(11018 4)		6.1		nC
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Gate-Sourc Gate-Drain	Charge					(11018 4)				-
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Gate-Sourc Gate-Drain	Charge de Character		nd Max	imum R	-	(10010 4)				-
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Gate-Sourc Gate-Drain Gource Dio Maximum C	Charge de Character Continuous Drain-S	Source Dio	nd Max	<b>imum R</b> ard Curren	-	(10012 4)			7.6	nC A
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Gate-Sourc Gate-Drain Source Dio Maximum C Maximum P	Charge de Character Continuous Drain-S Pulsed Drain-Source	Source Dio ce Diode F	nd Max ode Forwa	<b>imum R</b> ard Curren Current	t			6.1  	 7.6 30.4	A A
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S I <sub>S</sub> I <sub>SM</sub> V <sub>SD</sub>	Gate-Sourc Gate-Drain Source Dio Maximum C Maximum P Drain-Sourc	Charge <b>de Character</b> Continuous Drain-S Pulsed Drain-Sourc ce Diode Forward	Source Dio ce Diode F	nd Max ode Forwa Forward C V <sub>GS</sub> = C	<b>imum R</b> ard Curren Current O V, I <sub>S</sub> = 7.1	t 6 A			6.1  	 7.6 30.4 1.5	A A V
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S	Gate-Sourc Gate-Drain Cource Dio Maximum C Maximum P Drain-Sourc Reverse Re	Charge de Character Continuous Drain-S Pulsed Drain-Source	Source Dio ce Diode F	nd Max ade Forward C $V_{GS} = C$ $V_{GS} = C$	<b>imum R</b> ard Curren Current	6 A A,			6.1  	 7.6 30.4	A A A

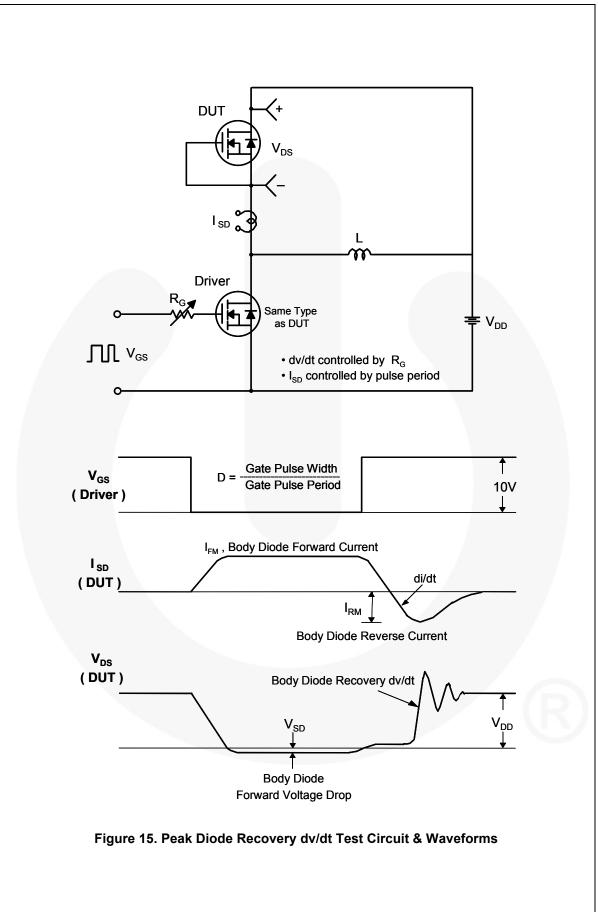
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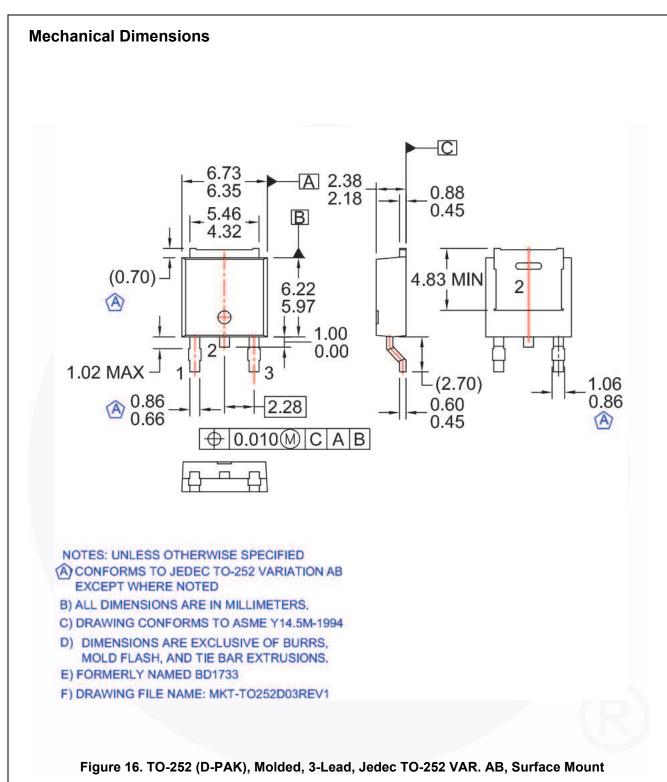


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